


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	ADG/21/13022	
1.3 Title of PCI	SOT223 - SOT323 - PowerFLAT 3x3 : Additional Carrier and Cover Tape Supplier	
1.4 Product Category	see list	
1.5 Issue date	2021-09-23	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	SAWTELLE KRISTIN
2.1.2 Phone	
2.1.3 Email	kristin.sawtelle@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Mario ASTUTI,Angelo RAO,Stephane CHAMARD,Maurizio GIUDICE
2.1.2 Marketing Manager	Anna RANIOLO,Michele SCUTO,Philippe LEGER,Natale Sandro D'ANGELO,Paolo PETRALI
2.1.3 Quality Manager	Vincenzo MILITANO,Jean-Paul REBRASSE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	New Indirect material part number (same supplier or different supplier): Boxes, trays, carriers, back grinding tape, wafer mounting tape, mold tape, etc..	Subcontractor TFME (China)

4. Description of change

	Old	New
4.1 Description	Carrier: KOSTAT Cover Tape: DENKA	Carrier: KOSTAT and Wuxi Furun Cover Tape: DENKA and SUMITOMO
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	Double Source Suppliers for Service improvement
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	Date code
------------------------	-----------

7. Timing / schedule

7.1 Date of qualification results	2021-09-15
7.2 Intended start of delivery	2021-10-31
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	13022 Qualification TFME Additional supplier for carrier and cover tape.pptx		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2021-09-23

9. Attachments (additional documentations)

13022 Public product.pdf
13022 PCI Add supplier TFME carrier and cover tape.pdf
13022 Qualification TFME Additional supplier for carrier and cover tape.pptx

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STN3P6F6	

IMPORTANT NOTICE – PLEASE READ CAREFULLY

Subject to any contractual arrangement in force with you or to any industry standard implemented by us, STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST’s terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers’ products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2018 STMicroelectronics – All rights reserved